

Power Management Switch IC Series for PCs and Digital Consumer Product

# Small Current Output Power Management Switch ICs

#### Description

The High-side switch for memory card slot is an IC High-side switch with a function of over-current protection used in the power supply line of a memory card slot. In the switch part an N channel MOSFET low ON resistance has been 1 circuit integrated.

The switch goes OFF when the over-current condition lasts longer than the over-current shutdown time. The OFF switch is set on latch off mode.

The operating voltage range is 2.7V to 3.6V and the current limit value is set on 400mA, 1A.

Moreover, a soft start function, an under voltage lockout function and an over temperature protection function are integrated.

#### Feature

- 1) Single low on-resistance (Typ. =  $150m\Omega$ ) Nch MOS FET
- 2) Continuous load current 0.2A(BD2202G) / 0.5A(BD2206G)
- 3) Control input logic: Active-High
- 4) Soft start function
- 5) Over current protection circuit
- 6) Over temperature protection circuit
- 7) Under voltage lockout
- 8) Power supply voltage range 2.7V~3.6V
- 9) Operating temperature range -25°C~85°C

#### Applications

Memory card slots of STB, Digital still camera, Cell Phones, Notebook PC.

#### ●Line up

Parameter	BD2202G	BD2206G
Continuous load current (A)	0.2	0.5
Short circuit current limit (A)	0.4	1.0
Logic Control input	High	High



#### •Absolute Maximum Ratings

Parameter	Symbol	Limits	Unit
Supply voltage	Vin	-0.3 to 6.0	V
En voltage	VEN	-0.3 to 6.0	V
OUT voltage	Vout	-0.3 to VIN + 0.3	V
Storage temperature	Tstg	-55 to 150	°C
Power dissipation	PD	675 <sup>*1</sup>	mW

\*1 Mounted on 70mm \* 70mm \* 1.6mm grass-epoxy PCB. Derating : 5.4mW/°C for operating above Ta=25°C

\* Does not do radiation resistance design.

\* There is no operation guarantee.

Operating conditions

#### ©BD2202G

Parameter	Symbol	Limits	Unit
Operating voltage range	Vin	2.7 to 3.6	V
Operating temperature range	TOPR	-25 to 85	°C
Operating load current	Ilo	0 to 200	mA

#### ©BD2206G

Parameter	Symbol	Limits	Unit
Operating voltage range	Vin	2.7 to 3.6	V
Operating temperature range	TOPR	-25 to 85	°C
Operating load current	Ilo	0 to 500	mA

#### Electrical characteristics

 $\bigcirc$ BD2202G (Unless otherwise specified, VIN = 3.3V, Ta = 25°C) DC characteristics

Parameter	Symbol	Limits		Linit	Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Operating current	IDD	-	70	90	μA	VEN = 3.3V, VOUT = OPEN
Standby current	Istb	-	0.01	1	μA	VEN = 0V, OUT = OPEN
		2.0	-	-	V	High level input
EN input voltage	VEN	-	-	0.8	V	Low level input
EN input current	IEN	-1.0	0.01	1.0	μA	VEN = 0V or VEN = 3.3V
ON resistance	Ron	-	150	200	mΩ	IOUT = 50mA
Short-circuit output current	Isc	200	-	600	mA	Vout = 0V
Output leak current	I <sub>LEAK</sub>	-	0.01	10	μA	Ven = 0V, Vout = 0V
UVLO threshold	Vτυνн	2.1	2.3	2.5	V	VIN increasing
	Vtuvl	2.0	2.2	2.4	V	VIN decreasing

#### AC characteristics

Deremeter	Querrahal	Limits			1.1	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Output rise time	TON1	0.25	1.2	6	ms	$R_{OUT}$ =500 $\Omega$ , $C_{OUT}$ =0.1 $\mu$ F
Output turn on time	Ton2	0.4	2	10	ms	$R_{OUT}$ =500 $\Omega$ , $C_{OUT}$ =0.1 $\mu$ F
Output fall time	TOFF1	50	100	200	μs	$R_{OUT}$ =500 $\Omega$ , $C_{OUT}$ =0.1 $\mu$ F
Output turn off time	TOFF2	50	100	200	μs	R <sub>OUT</sub> =500Ω, C <sub>OUT</sub> =0.1μF
Over current shutdown time 1	TBLANK 1	5	10	15	ms	At continuous over current
Over current shutdown time 2	TBLANK 2	3	-	15	ms	At discontinuous over current

# $\bigcirc$ BD2206G (Unless otherwise specified, VIN = 3.3V, Ta = 25°C) DC characteristics

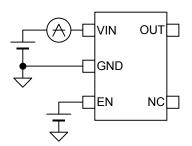
Deremeter	Question	Limits		1.1		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Operating current	IDD	-	70	90	μA	VEN = 3.3V, VOUT = OPEN
Standby current	Istb	-	0.01	1	μA	VEN = 0V, OUT = OPEN
		2.0	-	-	V	High level input
EN input voltage	Ven	-	-	0.8	V	Low level input
EN input current	len	-1.0	0.01	1.0	μA	VEN = 0V or VEN = 3.3V
ON resistance	Ron	-	150	200	mΩ	IOUT = 50mA
Short-circuit output current	I <sub>sc</sub>	750	-	1350	mA	Vout = 0V
Output leak current	I <sub>LEAK</sub>	-	0.01	10	μA	Ven = 0V, Vout = 0V
	ντυνη	2.1	2.3	2.5	V	VIN increasing
UVLO threshold	Vtuvl	2.0	2.2	2.4	V	VIN decreasing

#### AC characteristics

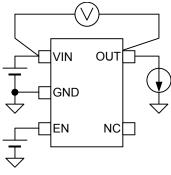
Deremeter	Symbol	Limits			1.1	Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Output rise time	TON1	0.25	1.2	6	ms	R <sub>out</sub> =500Ω, C <sub>out</sub> =0.1μF
Output turn on time	TON2	0.4	2	10	ms	$R_{OUT}$ =500 $\Omega$ , $C_{OUT}$ =0.1 $\mu$ F
Output fall time	TOFF1	50	100	200	μs	$R_{OUT}$ =500 $\Omega$ , $C_{OUT}$ =0.1 $\mu$ F
Output turn off time	TOFF2	50	100	200	μs	$R_{OUT}$ =500 $\Omega$ , $C_{OUT}$ =0.1 $\mu$ F
Over current shutdown time 1	TBLANK 1	5	10	15	ms	At continuous over current
Over current shutdown time 2	TBLANK 2	3	-	15	ms	At discontinuous over current

Measurement circuits

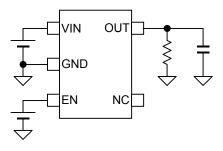
Timing diagrams



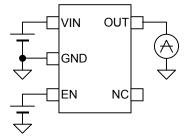
Operating current



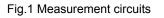
ON resistance



EN input voltage, Output rise / fall time

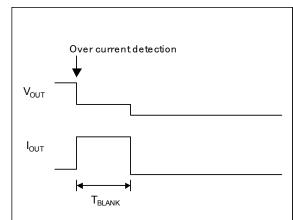


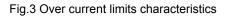
Over current protection characteristics



VEN 50% 50% TOFF2 90% 90% VOUT 10% TON1 TOFF1

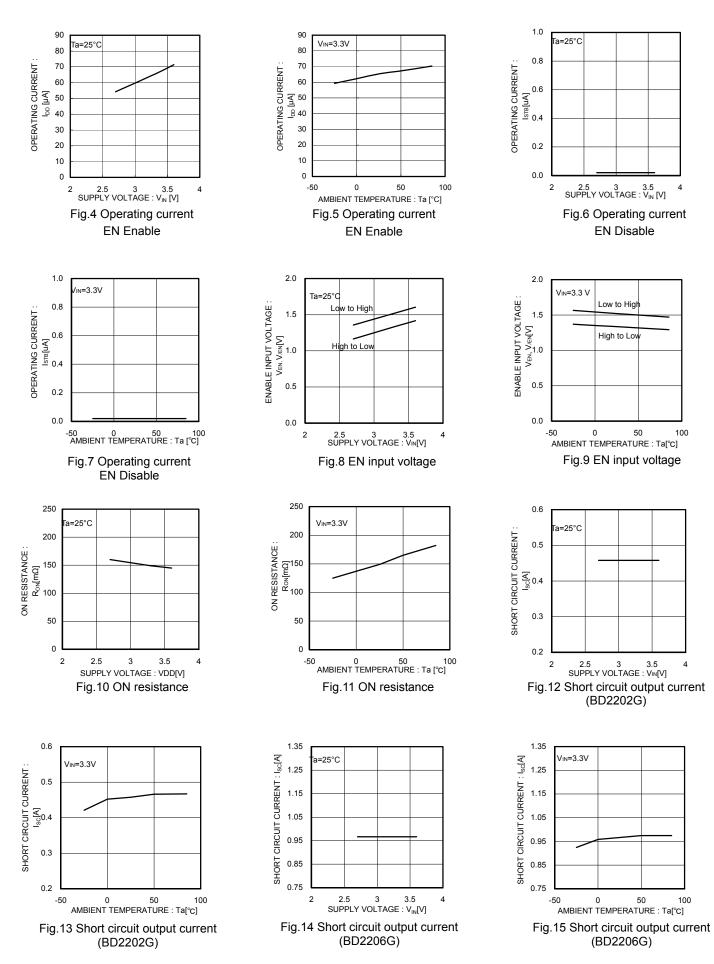
Fig.2 Switch Turn on / off time

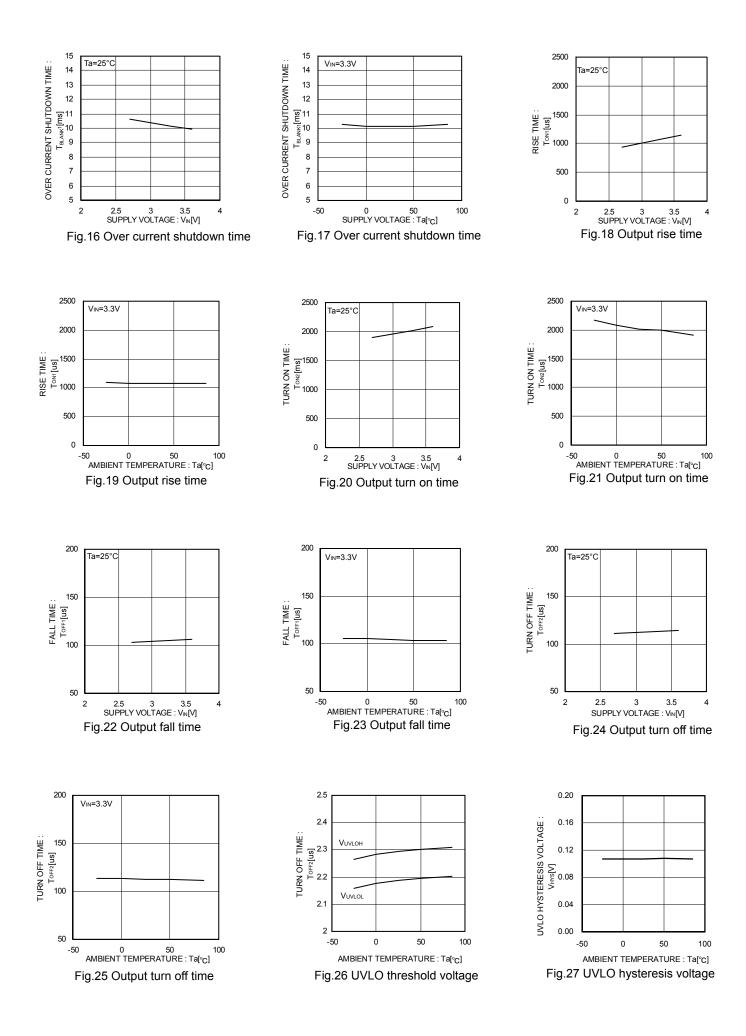




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#### Reference data





#### Waveform data

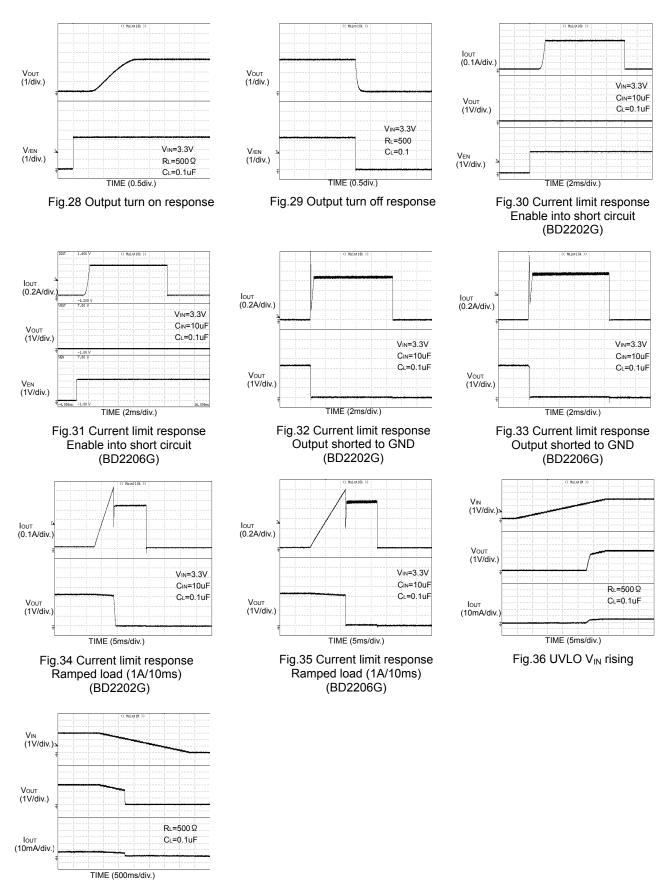


Fig.37 UVLO VIN falling

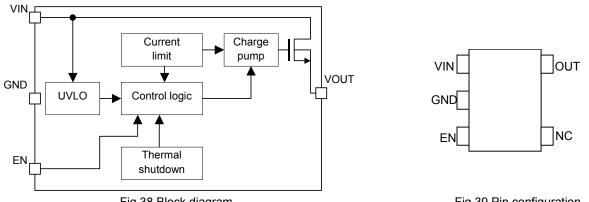


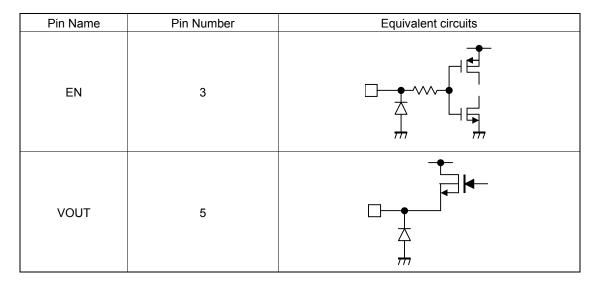
Fig.38 Block diagram

Fig.39 Pin configuration

#### Pin description

Pin Number	Pin Name	I/O	Pin function
			Power supply input terminal.
1	VIN	I	Input terminal to the power switch and power supply input terminal of the
			internal circuit.
2	GND	I	Ground.
3	EN		Power Switch enable input.
3	EIN	I	Active-High Switch on input. A logic high turns the switch on.
4	N.C	-	No connection. Not internally connected.
5	VOUT	0	Power switch output

#### ●I/O circuit



BD2202G and BD2206G are high side switch IC with over-current protection function. The operating voltage range is from 2.7V to 3.6V and the current limit value is set on 400mA, 1A.

When an over-current condition lasts longer than an over-current shutdown time, the switch turns OFF. The OFF switch is set on latch mode. The switch set on latch mode returns (to normal) by toggling EN pin from High to Low to High.

#### 1. Switch On/Off control

VIN and VOUT pins are connected to each switch MOSFET drain and source. Moreover, VIN pin is also used as a power supply input for the internal control circuit.

When the switch is turned on from EN control input, VIN and VOUT is connected by a  $150m\Omega$  switch. In normal condition, the switch shows bidirectional. Therefore, when the voltage of VOUT is higher than VIN the current flows from VOUT to VIN.

In the switch MOSFET, there is a parasitic diode (body diode) between drain and source. So, even when the switch is off, when voltage of VOUT is higher than VIN, the current flows through the body diode from VOUT to VIN.

2. Over current detection (OCD)

The over current detection circuit limits current when current flowing in switch MOSFET exceeds the current limit threshold. There are three types of response against over current. The over current detection circuit is in operation when the power switch is ON (when EN signal is active).

2-1 When the switch is turned on while the output is in short-circuit statusWhen the switch is turned on while the output is in short-circuit status, the switch become current limit mode soon.

2-2 When the output short-circuits while the switch is on

When the output short-circuits or heavy load is connected while the switch is on, very large current flows until the over current limit circuit responds. When the current detection, limit circuit works, current limitation is carried out.

#### 2-3 When the output current increases gradually

When the output current increases gradually, current limitation does not work until the output current exceeds the over current detection value. When it exceeds the detection value, current limitation is carried out.

3. Over current shutdown

When the over-current detection circuit detects an over-current, TBLANK timer starts working. When the over-current condition disappears before TBLANK2 stage, TBLANK timer is reset. When the over-current condition progresses to more than TBLANK1, the switch is shut off. The OFF switch is set on latch off mode. The latch is reset when EN terminal is toggled or when UVLO is detected.

#### 4. Under voltage lockout (UVLO)

UVLO keeps the power switch off until VIN voltage exceeds 2.3V (Typ.). Moreover, from a power switch ON situation, if VIN voltage drops to 2.2V (Typ.), the power switch is set on OFF. UVLO has a 100mV hysteresis. The under voltage lock out circuit is in operation when power switch is ON (when EN signal is active).

#### 5. Thermal shutdown

When the chip temperature increases to 160°C (Typ.), the thermal shut down circuit works and the power switch is turned OFF. When the chip temperature falls to 140°C (Typ.), the power switch output returns (to normal). This operation will repeat itself until the causes of the chip temperature rise are removed or until the power switch output is turned off. The thermal shutdown circuit is in operation when the power switch is ON (when EN signal is active).

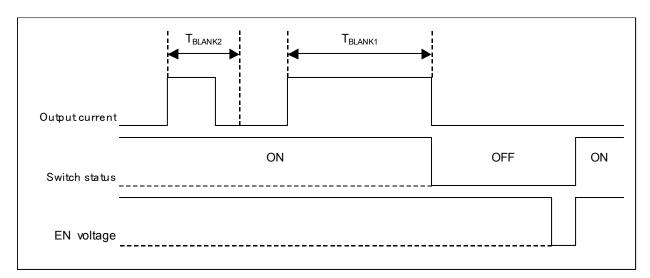


Fig.40 Over-current detection, shutdown operation (return with EN input)

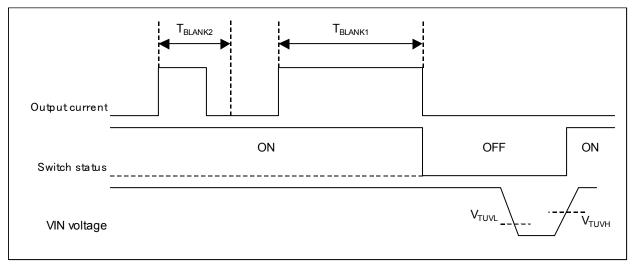


Fig.41 Over-current detection, shutdown operation (return with UVLO operation)

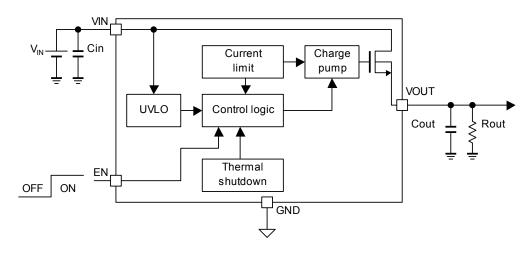


Fig.42 Typical application circuit

#### Application information

When an excessive current flows because of an output short circuit, a noise caused by the inductance of power supply to the IC breaks out and it is possible that it influences negatively the IC operation. In order to avoid this problem, please connect  $C_{IN}$  bypass capacitor close to the IC VIN and GND pins of the IC. More than 1µF is recommended.

Due to the internal body diode in the switch, a  $C_{IN}$  greater than  $C_{OUT}$  is highly recommended.

This system connection diagram does not guarantee operation as an application.

The external circuit constant and so on is changed and it uses, in which there are adequate margins by taking into account external parts or dispersion of IC including not only static characteristics but also transient characteristics.

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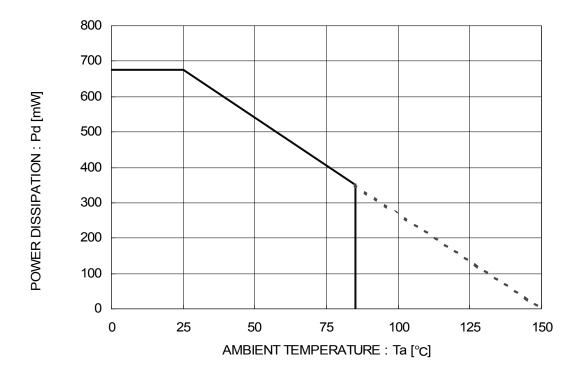


Fig.43 Power dissipation curve (Pd-Ta Curve)

#### Cautions on use

#### (1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

#### (2) Operating conditions

These conditions represent a range within which characteristics can be provided approximately as expected. The electrical characteristics are guaranteed under the conditions of each parameter.

#### (3) Reverse connection of power supply connector

The reverse connection of power supply connector can break down ICs. Take protective measures against the breakdown due to the reverse connection, such as mounting an external diode between the power supply and the IC's power supply terminal.

#### (4) Power supply line

Design PCB pattern to provide low impedance for the wiring between the power supply and the GND lines. In this regard, for the digital block power supply and the analog block power supply, even though these power supplies has the same level of potential, separate the power supply pattern for the digital block from that for the analog block, thus suppressing the diffraction of digital noises to the analog block power supply resulting from impedance common to the wiring patterns. For the GND line, give consideration to design the patterns in a similar manner.

Furthermore, for all power supply terminals to ICs, mount a capacitor between the power supply and the GND terminal. At the same time, in order to use an electrolytic capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

#### (5) GND voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

#### (6) Short circuit between terminals and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between terminals or between the terminal and the power supply or the GND terminal, the ICs can break down.

#### (7) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

#### (8) Inspection with set PCB

On the inspection with the set PCB, if a capacitor is connected to a low-impedance IC terminal, the IC can suffer stress. Therefore, be sure to discharge from the set PCB by each process. Furthermore, in order to mount or dismount the set PCB to/from the jig for the inspection process, be sure to turn OFF the power supply and then mount the set PCB to the jig. After the completion of the inspection, be sure to turn OFF the power supply and then dismount it from the jig. In addition, for protection against static electricity, establish a ground for the assembly process and pay thorough attention to the transportation and the storage of the set PCB.

(9) Input terminals

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input terminal. Therefore, pay thorough attention not to handle the input terminals, such as to apply to the input terminals a voltage lower than the GND respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input terminals when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input terminals a voltage lower than the guaranteed value of electrical characteristics.

#### (10) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

#### (11) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

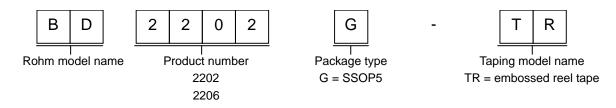
#### (12) Thermal shutdown circuit (TSD)

When junction temperatures become detected temperatures or higher, the thermal shutdown circuit operates and turns a switch OFF. The thermal shutdown circuit, which is aimed at isolating the LSI from thermal runaway as much as possible, is not aimed at the protection or guarantee of the LSI. Therefore, do not continuously use the LSI with this circuit operating or use the LSI assuming its operation.

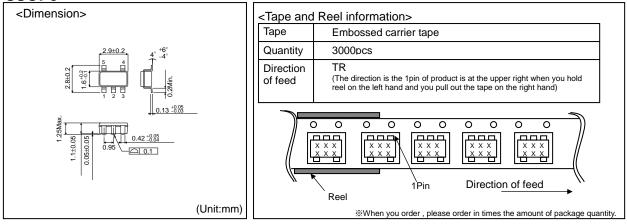
#### (13) Thermal design

Perform thermal design in which there are adequate margins by taking into account the power dissipation (Pd) in actual states of use.

Order model name selection



SSOP5



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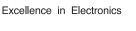
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EL: +86-20-8364-9796	FAX: +86-20-8364-9707
EL: +86-752-205-1054	FAX: +86-752-205-1059
EL: +86-592-238-5705	FAX: +86-592-239-8380
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